

# Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET** 

# Super J MOS<sup>®</sup> S2 series

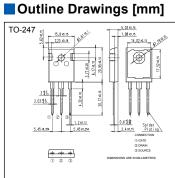
# N-Channel enhancement mode power MOSFET

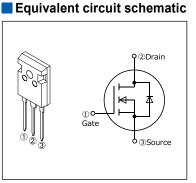
#### Features

Pb-free lead terminal **RoHS** compliant uses Halogen-free molding compound

#### Applications

For switching





### Absolute Maximum Ratings at T<sub>vi</sub>=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Drain Source Veltere	VDS	600	V	
Drain-Source Voltage	VDSX	600	V	V <sub>GS</sub> =-30V
Continuous Drain Current	,	47.9	А	T <sub>vj</sub> =25°C Note*1,2
Continuous Drain Current	I <sub>D</sub>	30.3	А	T <sub>vj</sub> =100°C Note*1,2
Pulsed Drain Current	I <sub>DP</sub>	148	А	Note *2
Gate-Source Voltage	Vgs	±30	V	
Non-Repetitive Maximum Avalanche Current	las	5.5	А	Note *3
Non-Repetitive Maximum Avalanche Energy	Eas	1177	mJ	Note *4
Maximum Drain-Source dV/dt	dV <sub>DS</sub> /dt	50	V/ns	V <sub>DS</sub> ≤ 600V
Continuous	,	47.9	А	T <sub>vj</sub> =25°C Note*1,2
Diode Forward Current	Isd	30.3	А	T <sub>vj</sub> =100°C Note*1,2
Pulsed Diode Forward Current	Isdp	148	А	Note *2
Peak Diode Recovery dV/dt	dV/dt	15	V/ns	Note *5
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *6
Maximum Dawar Disaination	D	2.50	10/	<i>T</i> ₂=25°C
Maximum Power Dissipation	PD	235	W	<i>T</i> <sub>vj</sub> =25°C
Oneverting and Stevens Temperature renge	Tch	150	°C	
Operating and Storage Temperature range	<b>T</b> stg	-55 to +150	°C	

Note \*1 : Maximum duty cycle D=0.60

Note \*1: Imited by maximum channel temperature. Note \*3: T<sub>ch</sub>≤150°C, See Fig.1 and Fig.2 Note \*4: Starting T<sub>oh</sub>=25°C, I<sub>A</sub>s=3.3A, L=198mH, V<sub>DD</sub>=60V, R<sub>G</sub>=50Ω, See Fig.1 and Fig.2 E<sub>AS</sub> limited by maximum channel temperature and avalanche current. Note \*5: I<sub>SD</sub>≤37.1A, -di/dt≤100A/µs, V<sub>DS peak</sub>≤600V, T<sub>ch</sub>≤150°C. Note \*6: I<sub>SD</sub>≤37.1A, dV/dt≤15V/ns, V<sub>DS peak</sub>≤600V, T<sub>ch</sub>≤150°C.

# Electrical Characteristics at T<sub>vj</sub>=25°C (unless otherwise specified) Static Ratings

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>ss</sub> =0V /₀=250µA		600	-	-	V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> I₀=1.95mA		3.5	4.0	4.5	V
Zero Gate Voltage Drain Current	loss	V <sub>DS</sub> =600V V <sub>GS</sub> =0V	T <sub>ch</sub> =25°C	-	-	25	μA
		V <sub>DS</sub> =480V V <sub>GS</sub> =0V	<i>T</i> <sub>ch</sub> =125°C	-	-	250	
Gate-Source Leakage Current	Igss	V <sub>DS</sub> =0V V <sub>GS</sub> =±30V		-	10	100	nA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V I <sub>D</sub> =18.6A		-	0.071	0.079	Ω
Gate resistance	RG	f=1MHz, open drain		-	7.2	-	Ω

#### Dynamic Ratings

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =25V I <sub>D</sub> =18.6A	12.2	24.5	-	S
Input Capacitance	Ciss	V <sub>DS</sub> =400V	-	2030	-	
Output Capacitance	Coss	V <sub>GS</sub> =0V	-	67	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	8.7	-	
Effective output capacitance, energy related (Note *7)	Co(er)	V <sub>DS</sub> =0400V V <sub>GS</sub> =0V	-	158	-	pF
Effective output capacitance, time related (Note *8)	C <sub>o(tr)</sub>	V <sub>DS</sub> =0400V V <sub>GS</sub> =0V I <sub>D</sub> =constant	-	633	-	
Turn-On Time	<b>t</b> <sub>d(on)</sub>	$V_{\text{OD}}$ =400V, $V_{\text{GS}}$ =10V $I_{\text{D}}$ =18.6A, $R_{\text{G}}$ =12 $\Omega$ See Fig.3 and Fig.4	-	28	-	- ns
	tr		-	98	-	
Town Off Time	t <sub>d(off)</sub>		-	140	-	
Turn-Off Time	ti		-	26	-	
Total Gate Charge	QG		-	80	-	nC
Gate-Source Charge	Q <sub>GS</sub>	V <sub>DD</sub> =400V, V <sub>GS</sub> =10V −I <sub>D</sub> =37.1A See Fig.5	-	29	-	
Gate-Drain Charge	QGD		-	34	-	
Drain-Source crossover Charge	Qsw		-	18	-	

Note \*7 :  $C_{0(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 400V. Note \*8 :  $C_{0(er)}$  is a fixed capacitance that gives the same charging times as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 400V.

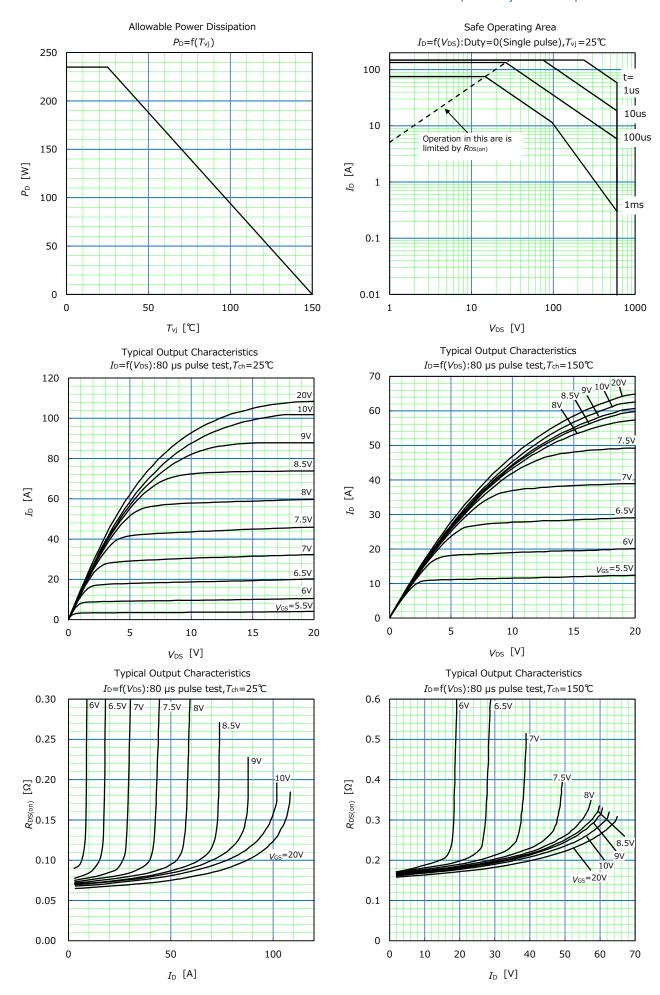
#### Reverse Diode

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Diode Forward On-Voltage	V <sub>SD</sub>	I <sub>SD</sub> =37.1A, V <sub>GS</sub> =0V T <sub>ch</sub> =25°C	-	0.90	1.35	V
Reverse Recovery Time	trr	- V <sub>oo</sub> =400V, / <sub>so</sub> =37.1A -di/dt=100A/μs <i>T</i> <sub>ch</sub> =25°C See Fig.6 and Fig.7	-	380	-	ns
Reverse Recovery Charge	Qrr		-	6.6	-	μC
Peak Reverse Recovery Current	<b>I</b> rp		-	34	-	А

#### Thermal Resistance

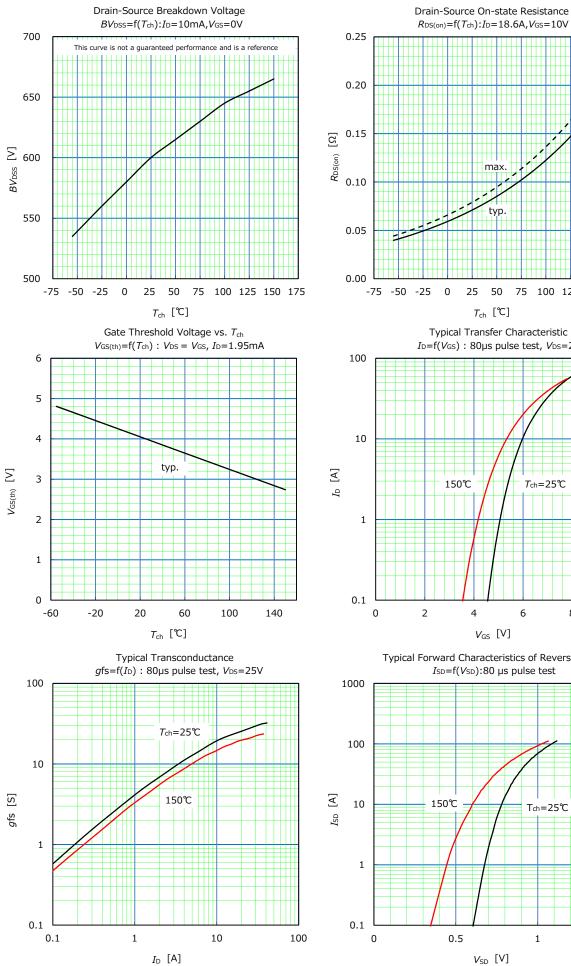
Parameter	Symbol	Min.	Тур.	Max.	Unit
Channel to Case	Rth(ch-c)	-	-	0.532	°C/W
Channel to Ambient	Rth(ch-a)	-	-	50	°C/W

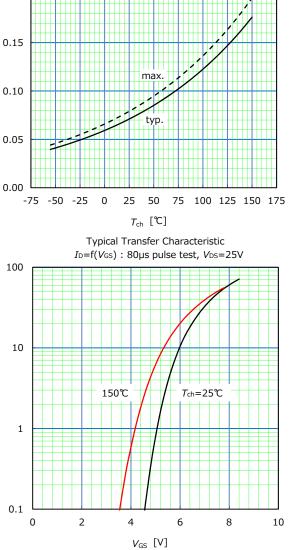
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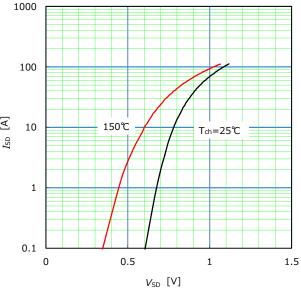
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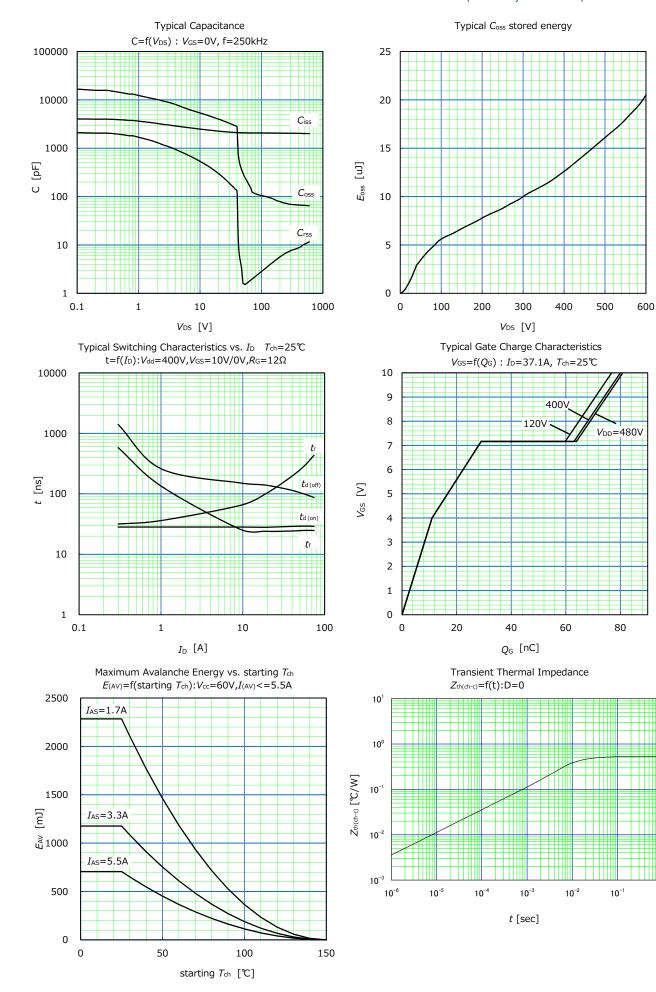
Typical Forward Characteristics of Reverse Diode  $I_{SD}=f(V_{SD}):80 \ \mu s \ pulse \ test$ 



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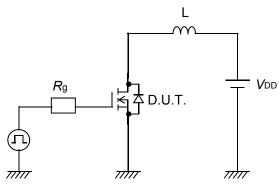


Fig.1 Avalanche Test circuit

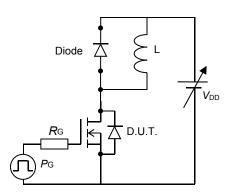


Fig.3 Switching Test circuit



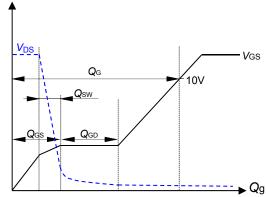
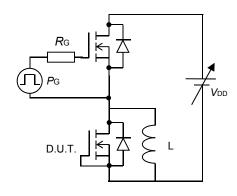
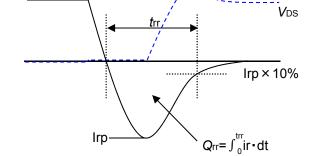


Fig.5 Operating waveform of Gate charge Test





. VDS peak

Fig.6 Reverse recovery Test circuit

Fig.7 Operating waveform of Reverse recovery Test

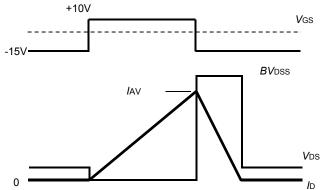


Fig.2 Operating waveforms of Avalanche Test

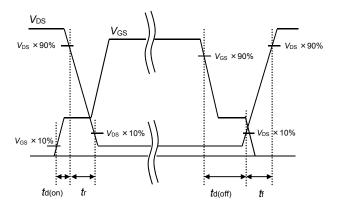


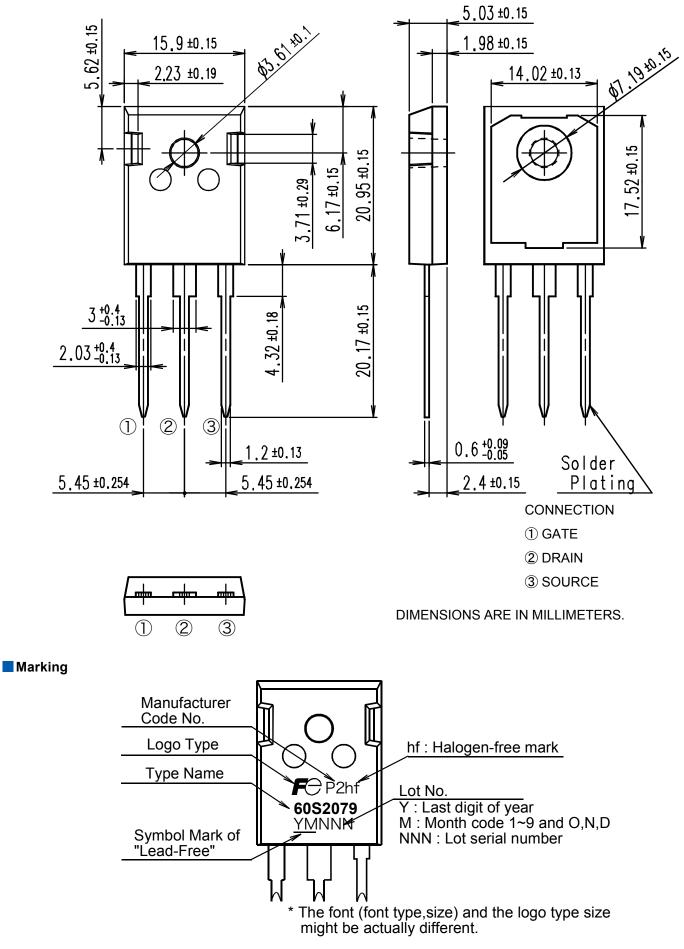
Fig.4 Operating waveform of Switching Test

**I**sd

## FMW60N079S2HF

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#### Outview: TO-247 Package



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